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INFORMATION BISCLOSURE STATEMENT BY APPLICANT PTO FORM 1449

ATTY P OCKET NO.	SERIAL NO. 09/768,959
APPLICANT: John H. NGUYEN	
FILING DATE	GROUP 2857

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	PATENT NUMBER	PATENT DATE	NAME	CLASS	SUBCLASS	FILING DATE
CN	3,283,304	November 1, 1996	Sinn, et al.			
(3	4,112,494	September 5, 1978	Elliot, et al.			
2	4,253,157	February 1981	Kirschner, et al.	PE	CEIVE	D
CN	4,318,184	March 1982	Millett, et al.		20	2
CN	4,644,529	February 17, 1987	Amstutz, et al.		11 0 8 20	
CH	4,657,727	April 14, 1987	Mlynczak, et al.	Techn	ology Cente	r 2100
CN	4,727,750	March 1998	Yonemura			
7	4,868,022	February 1990	Yumoto, et al.			
لوک	4,937,821	June 26, 1990	Boulton			
Col	4,991,087	February 5, 1991	Burkowski, et al.	-		
Cal	5,047,960	September 10, 1991	Sloan		<u> </u>	
10)	5,093,911	March 3, 1992	Parks, et al.			
CN	5,249,140	September 28, 1993	Kessler			
CN	5,290,110	March 1994	Takahashi	-		
W	5,329,465	July 12, 1994	Arcella, et al.	-		\
IN	5,347,623	September 13, 1994	Takano, et al.		<u> </u>	
CN	5,425,270	June 20, 1995	McDonald, et al.		-	
CN	5,550,737	August 27, 1996	Tedeschi		<u> </u>	
Cr	5,581,752	December 3, 1996	inoue, et al.			
Co	5,636,144	June 3, 1997	Kurtzberg, et al.	-		<u> </u>
W	5,708,909	January 1998	Yamashita, et al.		 	
1	5,745,899	April 28, 1998	Витоws		<u> </u>	
Cr	5,768,578	June 16, 1998	Kirk, et al.		 _ _	
Co	5,799,299	August 25, 1998	Fujiwara	-	-	
CV	5,887,171	March 23, 1999	Tada, et al	-	1=	
Co	5,943,236	August 24, 1999	Ohno, et al.	-	1_	
Col	6,049,827	April 2000	Sagauchi, et al.		1	-

⁻ If pertinent

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EXAMINER INITIAL	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	NO
					·		

OTHER DOCUMENTS				
EXAMINER INITIAL	,	AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.		

EXAMINER C. NGUTEN DATE CONSIDERED 03/04/04

EXAMINER: Initial if citation considered, whether or not citation is in conformance with M.P.E.P. 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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